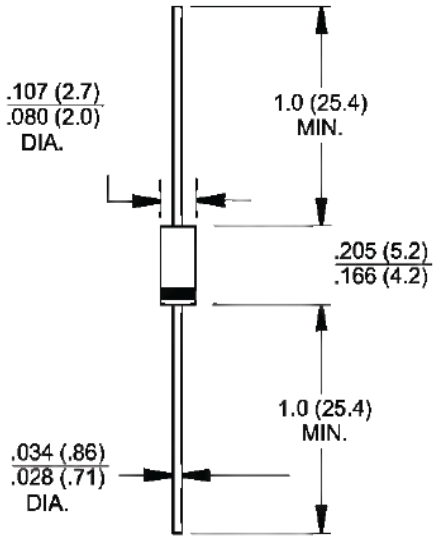
TAIWAN SEMICONDUCTOR

RoHS COMPLIANCE

BA157 - BA159

1.0AMP Fast Recovery Rectifiers

DO-41



Dimensions in inches and (millimeters)

Features

- ✧ High efficiency, Low VF
- ✧ High current capability
- ✧ High reliability
- ✧ High surge current capability
- ✧ Low power loss
- ✧ Green compound with suffix "G" on packing code & prefix "G" on datecode

Mechanical Data

- ✧ Cases: DO-41 Molded plastic
- ✧ Epoxy: UL 94V-0 rate flame retardant
- ✧ Lead: Pure tin plated, lead free, solderable per MIL-STD-202, Method 208 guaranteed
- ✧ Polarity: Color band denotes cathode end
- ✧ High temperature soldering guaranteed: 260℃/10s /.375", (9.5mm) lead lengths at 5 lbs, (2.3kg) tension
- ✧ Weight: 0.34 grams

Marking Diagram

BA15X = Specific Device Code
G = Green Compound
Y = Year
WW = Work Week

Maximum Ratings and Electrical Characteristics

Rating at 25 ℃ ambient temperature unless otherwise specified.
Single phase, half wave, 60 Hz, resistive or inductive load.
For capacitive load, derate current by 20%

Type Number	Symbol	BA157	BA158	BA159	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	400	600	1000	V
Maximum RMS Voltage	V_{RMS}	280	420	700	V
Maximum DC Blocking Voltage	V_{DC}	400	600	1000	V
Maximum Average Forward Rectified Current .375 (9.5mm) Lead Length @ T_A=45℃	$I_{F(AV)}$	1			A
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	30			A
Maximum Instantaneous Forward Voltage (Note 1) @ 1 A	V_F	1.2			V
Maximum DC Reverse Current at @ T_A=25 ℃ Rated DC Blocking Voltage @ T_A=125 ℃	I_R	5 150			uA uA
Maximum Reverse Recovery Time (Note 2)	Trr	150		250	nS
Typical Junction Capacitance (Note 3)	Cj	10			pF
Typical Thermal Resistance (Note 4)	$R_{\theta JA}$	65			^{O}C/W
Operating Temperature Range	T_J	- 65 to + 150			^{O}C
Storage Temperature Range	T_{STG}	- 65 to + 150			^{O}C

Note 1: Pulse Test with PW=300 usec, 1% Duty Cycle

Note 2: Reverse Recovery Test Conditions: I_F=0.5A, I_R=1.0A, I_{RR}=0.25A

Note 3: Measured at 1 MHz and Applied Reverse Voltage of 4.0V D.C.

Note 4: Mount on Cu-Pad Size 5mm x 5mm on PCB

RATINGS AND CHARACTERISTIC CURVES (BA157 THRU BA159)

FIG.1- MAXIMUM FORWARD CURRENT DERATING CURVE

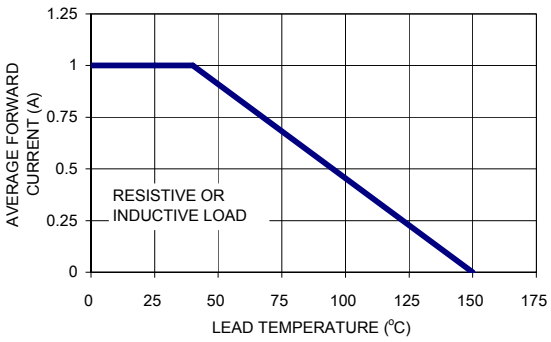


FIG. 2- TYPICAL REVERSE CHARACTERISTICS PER LEG

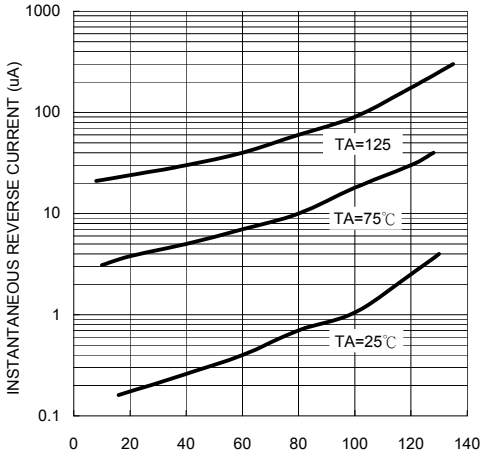


FIG. 3- MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

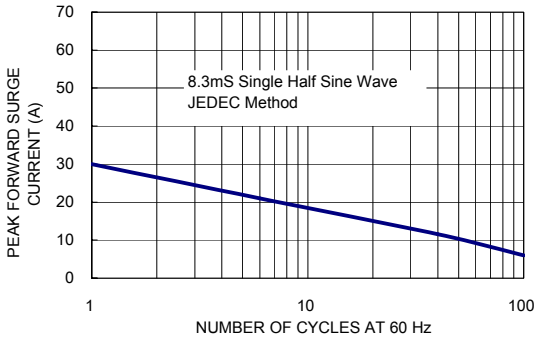


FIG. 5- TYPICAL FORWARD CHARACTERISRICS

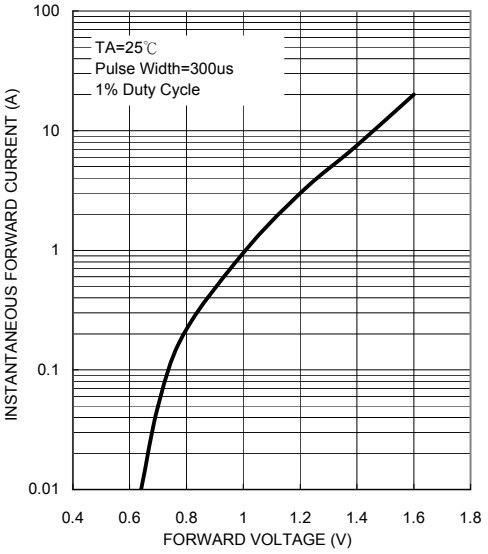


FIG. 4- TYPICAL JUNCTION CAPACITANCE

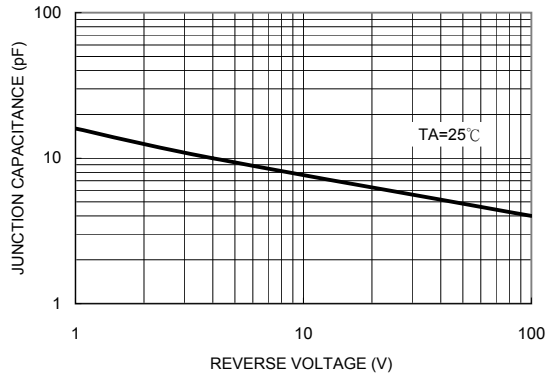
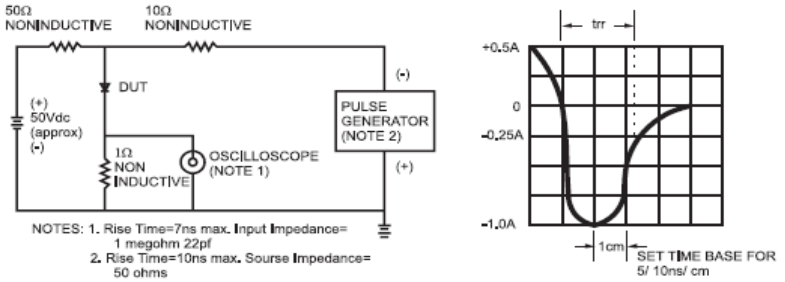


FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM



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